Data Sheet

Customer : _____

Part No : CL-SFC506USD-01(H)

Sample No : _____

Description : 5050 Red SMD

Item No : _____

Customer			
Check	Inspection	Approval	Date

Features：

■Wide Viewing Angle 120°

■Suitable for all SMT assembly and solder process.

■High Luminous Intensity and Low Power Dissipation.

■Good Reliability and Long Life

■Complied With RoHS Directive

Applications ：

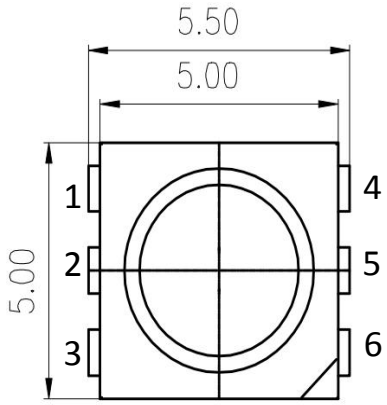
■ Optical indicator

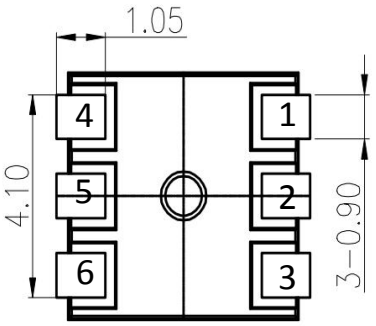
■ Retrofits(replacement)

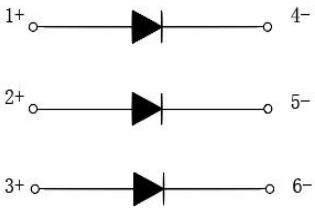
■ Backlighting in dashboard and switch

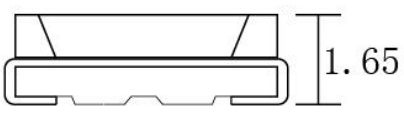
■Tubular light application

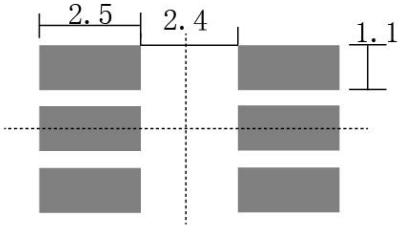
■ General use











Notes：

1 . All dimension units are millimeters.

2. All dimension tolerance is ±0.1mm unless otherwise noted.

Selection Guide

Part No.	Chip Materials	Lens Type	Luminous intensity(mcd) @ 60mA			Viewing Angle
			Min	Typ	Max	2θ1/2
CL-SFC506USD-01(H)	Red (AIGaInp)	Water Clear	2200	- -	3800	120

Note:

1.2θ1/2 is the angle from optical centerline where the luminous intensity is 2θ1/2 the optical centerline value.

2.The above luminous intensity measurement allowance tolerance ±10%

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Typ.	Max	Units	test conditions
Forward Voltage	VF	1.8	- -	2.4	V	IF=60mA
Reverse Current	IR	- -	- -	10	uA	VR = 5V
Dominate Wavelength	λd	616	- -	625	nm	IF=60mA

Absolute Maximum Ratings at Ta=25°C

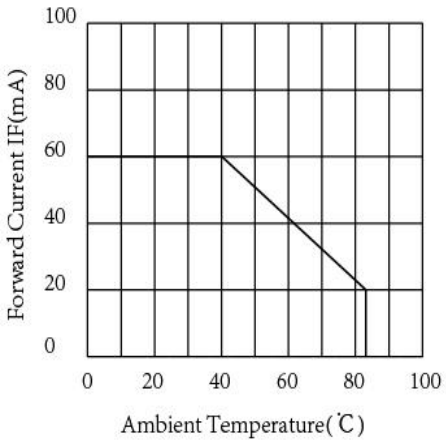
Parameter	Symbol	Rating	Units
Power Dissipation	Pd	144	mW
DC Forward Current	IF	60	mA
Peak Forward Current [1]	IFP	150	mA
Reverse Voltage	VR	5	V
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Tstg	-40~+100	°C

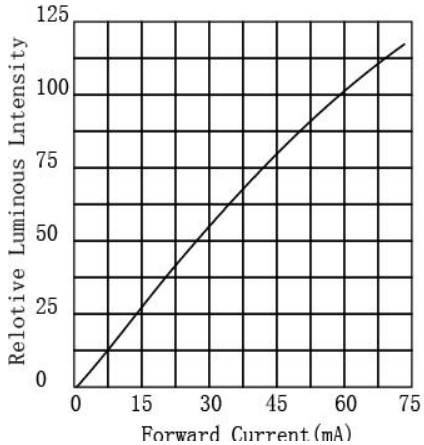
Note:

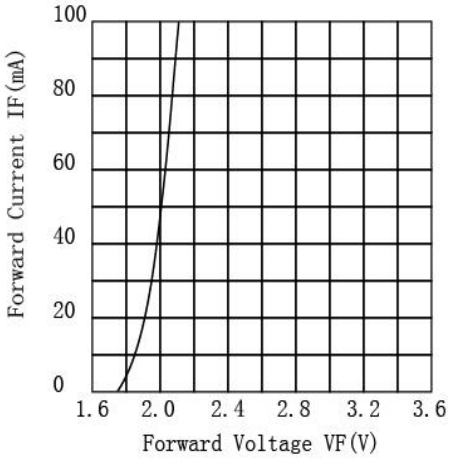
1. 1/10 Dut cycle,0.1ms pulse width.
2. The above forward voltage measurement allowance tolerance is ±0.1V.
3. The tolerance of wave length:±1nm.

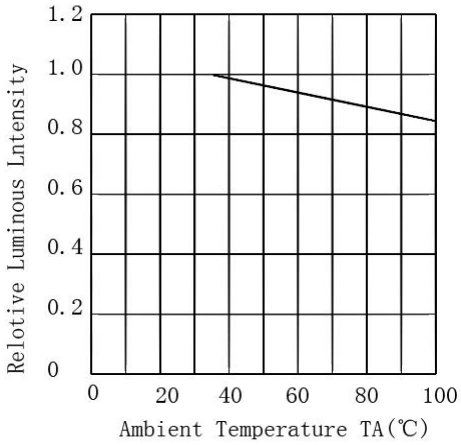
Typical optical characteristics curves

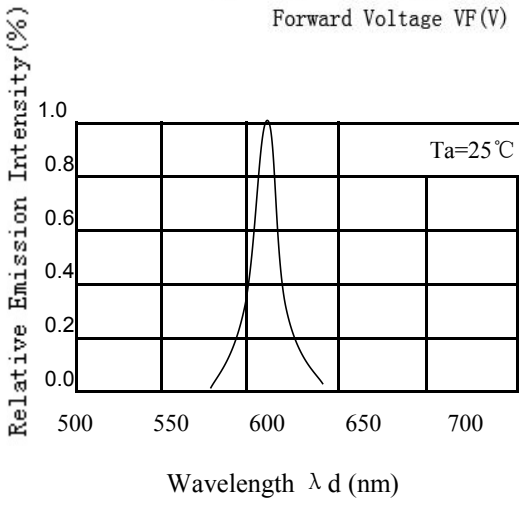
Ambient Temperature VS. Forward Current

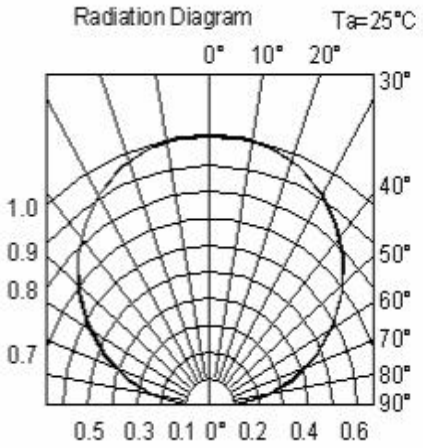












Reliability Test Items And Conditions

Test Items	Ref.Standard	Test conditions	Time	Quantity	Ac/Re
Reflow	JESD22-B106	Temp:260℃max T=10 sec	3 times.	22Pcs.	0/1
Temperature Cycle	JESD22-A104	100℃±5℃ 30 min. ↑↓5 min -40℃±5℃ 30 min.	100 Cycles	22Pcs.	0/1
High Temperature Storage	JESD22-A103	Temp:100℃±5℃	1000Hrs	22Pcs.	0/1
Low Temperature Storage	JESD22-A119	Temp:-40℃±5℃	1000Hrs	22Pcs.	0/1
Life Test	JESD22-A108	Ta=25℃±5℃ IF=60mA	1000Hrs	22Pcs.	0/1
High Temperature High Humidity Life Test	JESD22-A101	85℃±5℃/ 85%RH IF=60mA	1000Hrs	22Pcs.	0/1

Criteria For Judging Damage

Test Items	Symbol	Test conditions	Criteria For Judgement	
			Min.	Max.
Forward Voltage	VF	IF=60mA		U.S.L*)x1.1
Reverse Current	IR	VR = 5V		U.S.L*)x2.0
Luminous intensity	IV	IF=60mA	L.S.L*)x0.7	

U.S.L: Upper standard level L.S.L: Lower standard level

The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products.It does not constitute the warranting of industrial property nor the granting of any license.

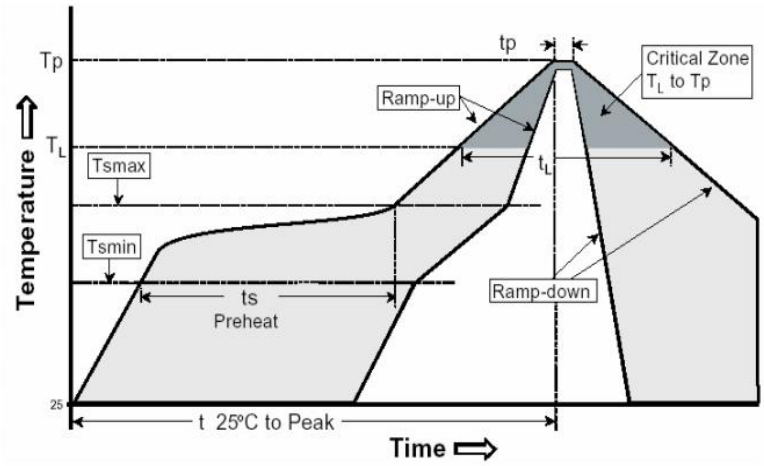
SMT Reflow Soldering Instructions

1. The number of reflow soldering shall not exceed two times,and the time from the second processing to the first

2. When soldering , do not put stress on the LEDs during heating .

3.Reflow temperature distribution (Acc.to J-STD-020D)

Profile Feature	Sn-Pb Eutectic Assembly		Pb-Free Assembly	
	Large Body	Small Body	Large Body	Small Body
Average ramp-up rate (TL to Tp)	3℃/second max.		3℃/second max.	
Preheat -Temperature Min(TSmin) -Temperature Max(TSmax) -Time(min to max)(ts)	100℃ 150℃ 60-120 seconds		150℃ 200℃ 60-180 seconds	
Tsmax to TL -Ramp-up Rate			3℃/second max.	
Time maintained above: -Temperature(TL) -Time(tL)	183℃ 60-150 seconds		217℃ 60-150 seconds	
Peak Temperature(Tp)	225+0/-5℃	240+0/-5℃	245+0/-5℃	260+0/-5℃
Time within 5℃ of actual Peak Temperature(tp)	10-30 seconds	10-30 seconds	10-30 seconds	20-40 seconds
Ramp-down Rate	6℃/second max.		6℃/second max.	
Time 25℃ to Peak Temperat	6 minutes max.		8 minutes max.	



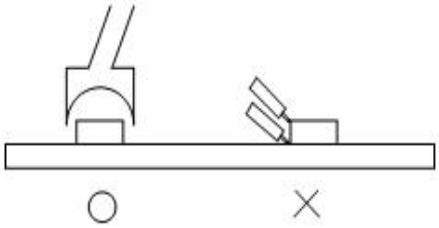
Soldering iron

1.When hand soldering, the temperature of the iron must less than 350℃ for 3 seconds

2.The hand solder should be done only one times

Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used(as below figure). It should be confirmed in advance whether the characteristics of LEDs will or will not be damaged by repairing.



Storage

This product uses sealing anti-moisture antistatic packaging, and with desiccant, humidity card.

Before packaging is opened:

1. The storage environment is: the ambient temperature should be maintained between 5 ° C and 30 ° C, and the relative humidity should be kept within 60% RH. (The storage period is 2 months. If more than two months, please return the product to our company to help dehumidify)

2. Please check the package for leaks before opening. If there is a leak, return to the factory for dehumidification.

After opening the package:

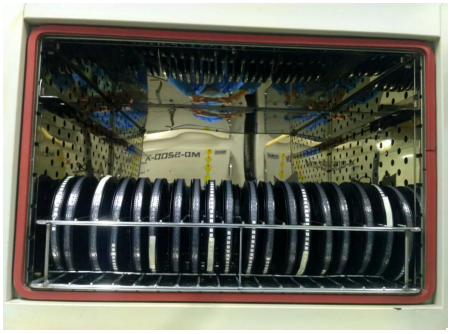
1. After opening the package, check whether the humidity card has a discoloration phenomenon. Please remove the material from the bag and use it after dehumidifying 24H at 65 °C.

2. Environmental conditions: The ambient temperature should be kept between ≤ 30 ° C and relative humidity The lower 60 % RH should be maintained.

3. if the material is not produced after exposure in the workshop for more than 24 hours, the product must be put back in the oven, dehumidified with 65 °C 24H, and then can be used again. If the material is not produced after 48 hours of exposure in the workshop, return the material to the SMD plant for high temperature dehumidification.

4. When the material is dehumidified, please do not open the oven in the middle, so that the oven temperature will not drop to the dehumidification effect.

Please refer to the following operating methods when the material needs to be dehumidified



Correct way: material desiccant need to remove the bag, use the way of hanging baked
正确的方法：材料需要去掉袋子，使用挂烤的方式烘烤。

Wrong way: the material is dehumidified without removing the bag, in a stacking manner
错误的做法是：以堆叠方式或材料不取出袋子烘烤。

ESD

Static Electrisity will damage the LED.

The following steps can reduce the likelihood of ESD causing product damage

1. All productive machinery and test instruments must be electrically grounded.

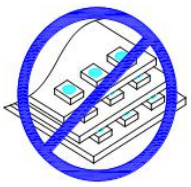
2. Use a condustive wrist band or anti-electostatic glove when handling these LEDs.

3. Manintain a humidity level of 50%RHor higher in production areas.

4. Use anti-static packaging for transport and storage.

Handling Precautions

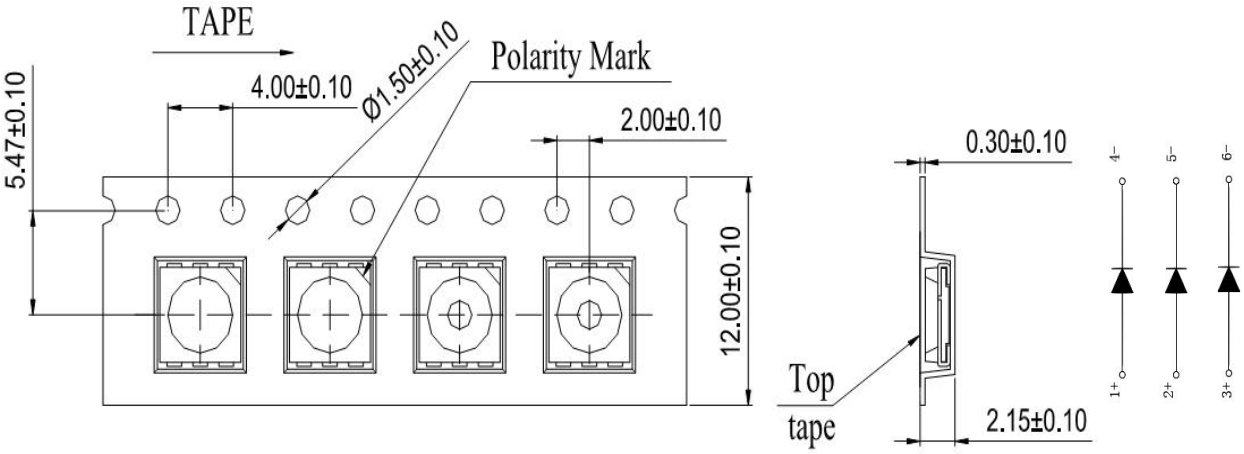
1. Do not stack the assembled PCB together. This may scratch the surface of the product or damage the circuit.



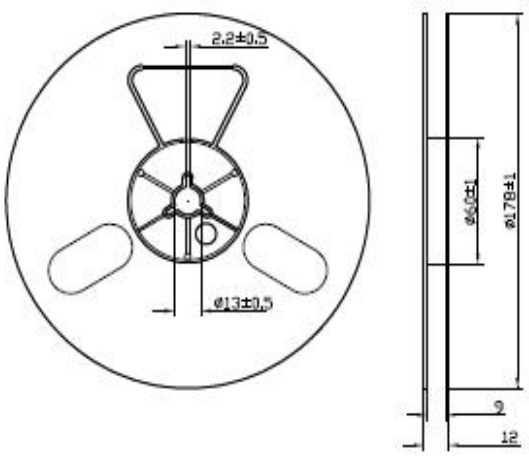
2. Not available in the situation of acidity for PH.

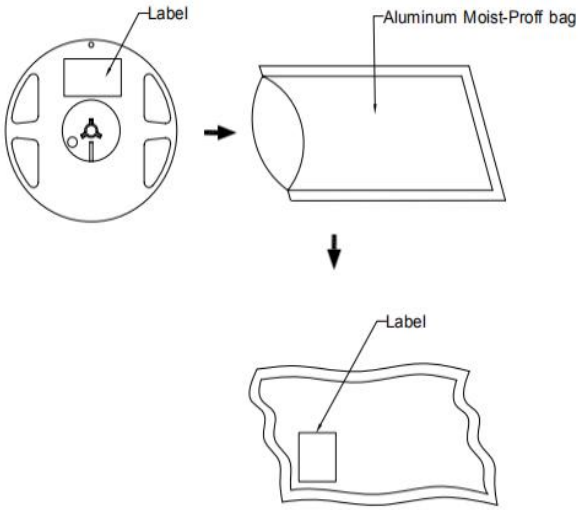
3. Electrostatic sensitive device

Package：1000pcs/reel



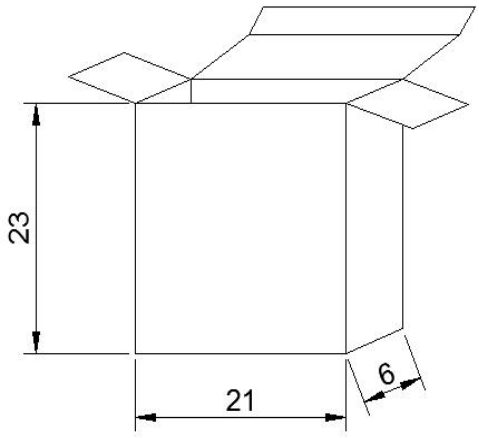
Moisture Resistant Packaging





Cardboard Box

Maximum packing quantity (5 packs of material)



Maximum packing quantity (27 bags of material or 5 small boxes)